Power MOSFET, 190 A

SOT-227

FEATURES

- Fully isolated package
- Very low on-resistance
- Fully avalanche rated
- Dynamic dV/dt rating
- Low drain to case capacitance
- Low internal inductance
- Optimized for SMPS applications
- Easy to use and parallel
- Industry standard outline
- Designed and qualified for industrial level
- UL approved file E78996
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

Pb-free

RoHS COMPLIANT

PRIMARY CHARACTERISTICS	
V_{DSS}	100 V
I_D DC	190 A
$R_{DS(on)}$	6.5 mΩ
Type	Modules - MOSFET
Package	SOT-227

DESCRIPTION

High current density power MOSFETs are paralleled into a compact, high power module providing the best combination of switching, ruggedized device design, very low on-resistance and cost effectiveness.

The isolated SOT-227 package is preferred for all commercial-industrial applications at power dissipation levels to approximately higher than 500 W. The low thermal resistance and easy connection to the SOT-227 package contribute to its universal acceptance throughout the industry.

ABSOLUTE MAXIMUM RATINGS				
PARAMETER	**SYMBOL**	**TEST CONDITIONS**	**MAX.**	**UNITS**
Continuous drain current at V_{GS} 10 V	I_D	T_C = 40 °C	190	A
		T_C = 100 °C	130	
Pulsed drain current	I_{DM}		720	
Power dissipation	P_D	T_C = 25 °C	568	W
Linear derating factor			2.7	W/°C
Gate to source voltage	V_{GS}		± 20	V
Single pulse avalanche energy	E_{AS} (2)		700	mJ
Avalanche current	I_{AR} (1)		180	A
Repetitive avalanche energy	E_{AR} (1)		48	mJ
Peak diode recovery dV/dt	dV/dt (3)		5.7	V/ns
Operating junction and storage temperature range	T_J, T_{Stg}		-55 to +150	°C
Insulation withstand voltage (AC-RMS)	V_{ISO}		2.5	kV
Mounting torque		M4 screw	1.3	Nm

Notes

(1) Repetitive rating; pulse width limited by maximum junction temperature

(2) Starting T_J = 25 °C, L = 43 µH, R_g = 25 Ω, I_{AS} = 180 A

(3) $I_{SD} \leq 180$ A, dI/dt ≤ 83 A/µs, $V_{DD} \leq V_{(BR)DSS}$, $T_J \leq 150$ °C

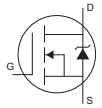
THERMAL - MECHANICAL SPECIFICATIONS

PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Junction and storage temperature range	T_J, T_{Stg}		-55	-	150	°C
Junction to case	R_{thJC}		-	-	0.22	°C/W
Case to heatsink	R_{thCS}	Flat, greased surface	-	0.05	-	
Weight			-	30	-	g
Mounting torque		Torque to terminal	-	-	1.1 (9.7)	Nm (lbf.in)
		Torque to heatsink	-	-	1.8 (15.9)	Nm (lbf.in)
Case style			SOT-227			

ELECTRICAL CHARACTERISTICS (T_J = 25 °C unless otherwise noted)

PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Drain to source breakdown voltage	$V_{(BR)DSS}$	V_{GS} = 0 V, I_D = 250 µA	100	-	-	V
Breakdown voltage temperature coefficient	$\Delta V_{(BR)DSS}/\Delta T_J$	Reference to 25 °C, I_D = 1 mA	-	0.093	-	V/°C
Static drain to source on-resistance	$R_{DS(on)}$	V_{GS} = 10 V, I_D = 180 A	-	5.4	6.5	mΩ
Gate threshold voltage	$V_{GS(th)}$	V_{DS} = V_{GS}, I_D = 250 µA	2.0	3.3	4.35	V
Forward transconductance	g_{fs}	V_{DS} = 25 V, I_D = 180 A	93	-	-	S
Drain to source leakage current	I_{DSS}	V_{DS} = 100 V, V_{GS} = 0 V	-	-	50	µA
		V_{DS} = 80 V, V_{GS} = 0 V, T_J = 125 °C	-	-	500	
Gate to source forward leakage	I_{GSS}	V_{GS} = 20 V	-	-	200	nA
		V_{GS} = - 20 V	-	-	- 200	
Total gate charge	Q_g	I_D = 180 A V_{DS} = 80 V V_{GS} = 10 V	-	250	-	nC
Gate to source charge	Q_{gs}		-	40	-	
Gate to drain (“Miller”) charge	Q_{gd}		-	110	-	
Turn-on delay time	$t_{d(on)}$	V_{DD} = 50 V I_D = 180 A R_g = 2.0 Ω (internal) R_D = 0.27 Ω	-	45	-	ns
Rise time	t_r		-	351	-	
Turn-off delay time	$t_{d(off)}$		-	181	-	
Fall time	t_f		-	335	-	
Internal source inductance	L_S	Between lead, and center of die contact	-	5.0	-	nH
Input capacitance	C_{iss}	V_{GS} = 0 V V_{DS} = 25 V f = 1.0 MHz	-	10 700	-	pF
Output capacitance	C_{oss}		-	2800	-	
Reverse transfer capacitance	C_{rss}		-	1300	-	

SOURCE-DRAIN RATINGS AND CHARACTERISTICS

PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Continuous source current (body diode)	I_S	MOSFET symbol showing the integral reverse p-n junction diode. 	-	-	190	A
Pulsed source current (body diode)	I_{SM}		-	-	740	
Diode forward voltage	V_{SD}	T_J = 25 °C, I_S = 180 A, V_{GS} = 0 V	-	1.0	1.3	V
Reverse recovery time	t_{rr}	T_J = 25 °C, I_F = 180 A, dI/dt = 100 A/µs	-	300	-	ns
Reverse recovery charge	Q_{rr}		-	2.6	-	µC
Forward turn-on time	t_{on}	Intrinsic turn-on time is negligible (turn-on is dominated by L_S + L_D)				

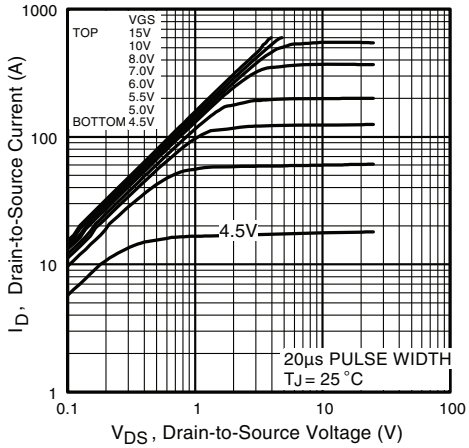


Fig. 1 - Typical Output Characteristics

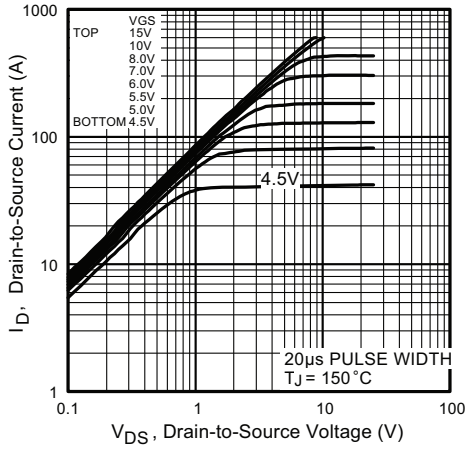


Fig. 2 - Typical Output Characteristics

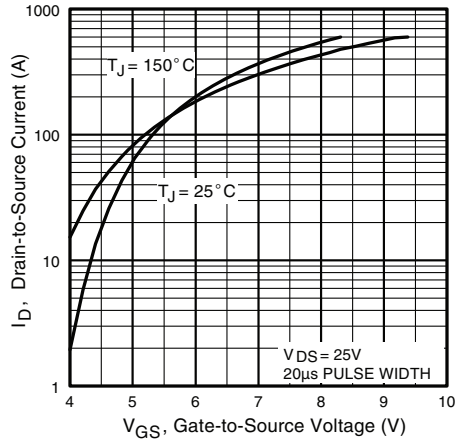


Fig. 3 - Typical Transfer Characteristics

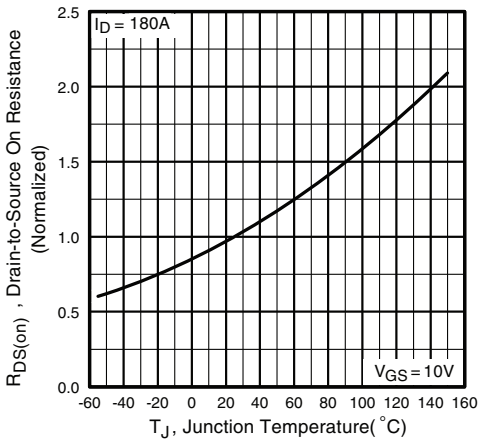


Fig. 4 - Normalized On-Resistance vs. Temperature

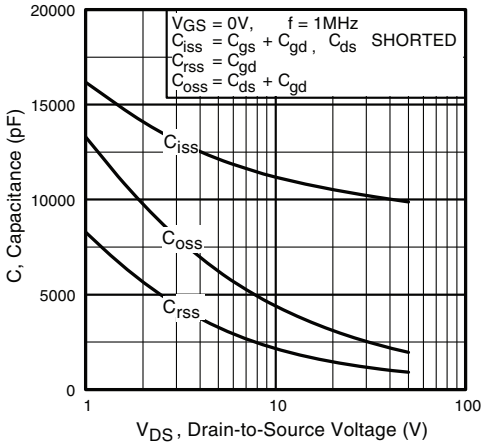


Fig. 5 - Typical Capacitance vs. Drain to Source Voltage

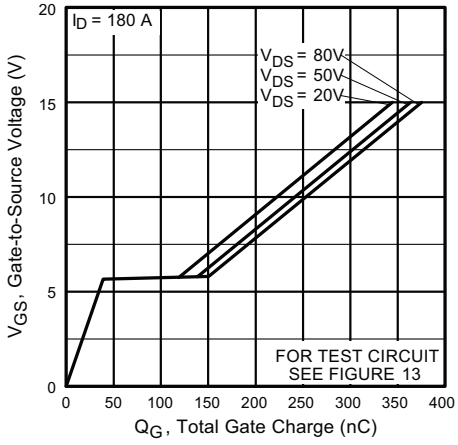


Fig. 6 - Typical Gate Charge vs. Gate to Source Voltage

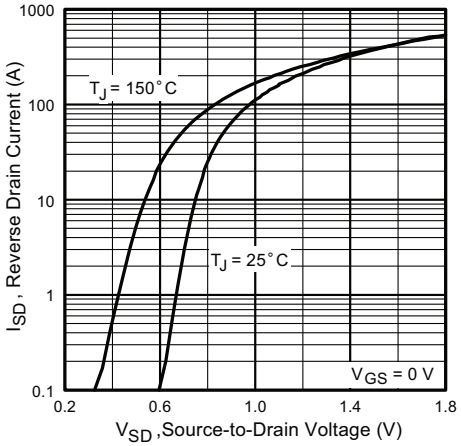


Fig. 7 - Typical Source Drain Diode Forward Voltage

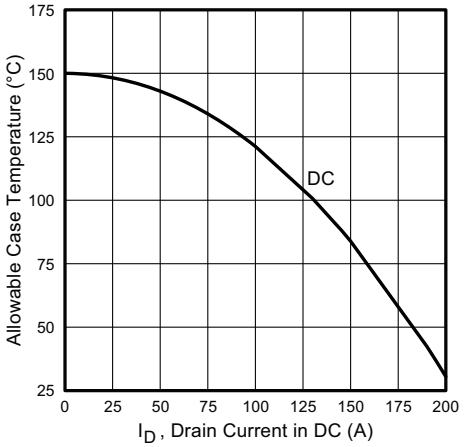


Fig. 9 - Maximum Drain Current vs. Case Temperature

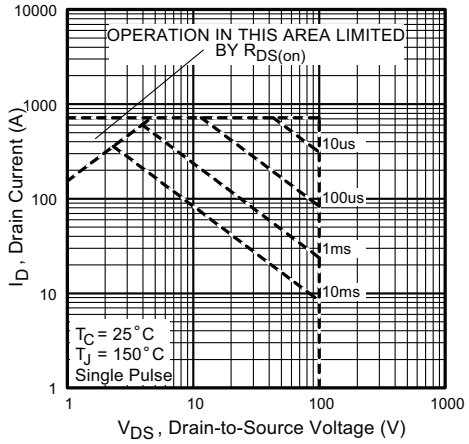


Fig. 8 - Maximum Safe Operating Area

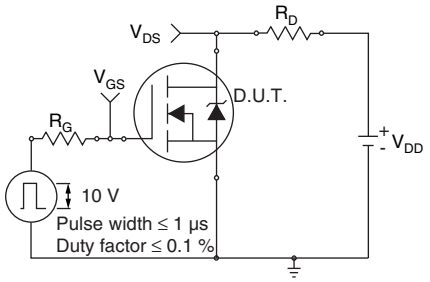


Fig. 10 - Switching Time Test Circuit

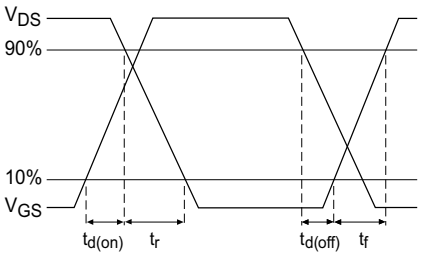


Fig. 11 - Switching Time Waveforms

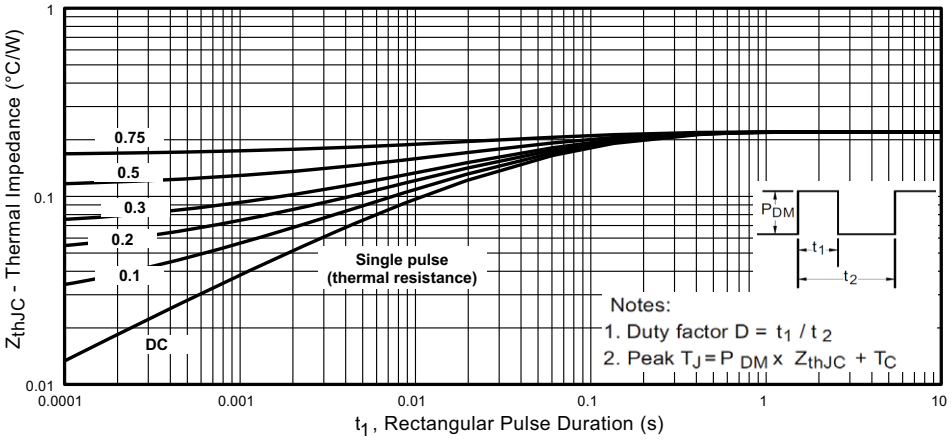


Fig. 12 - Maximum Effective Transient Thermal Impedance, Junction to Case

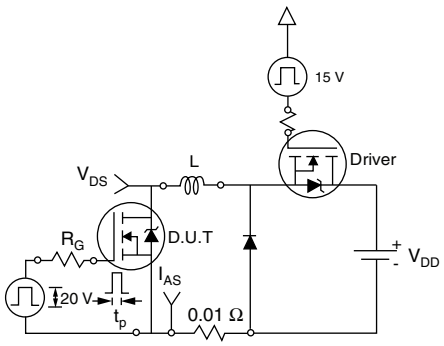


Fig. 13 - Unclamped Inductive Test Circuit

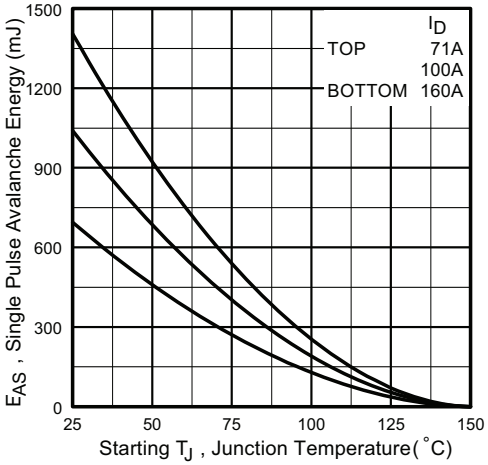


Fig. 15 - Maximum Avalanche Energy vs. Drain Current

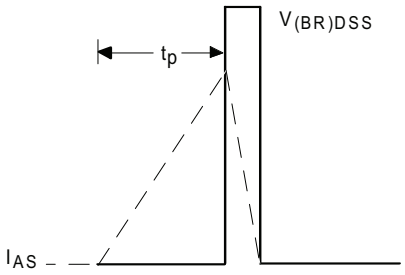


Fig. 14 - Unclamped Inductive Waveforms

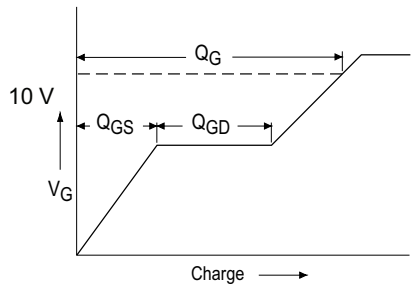


Fig. 16 - Basic Gate Charge Waveform

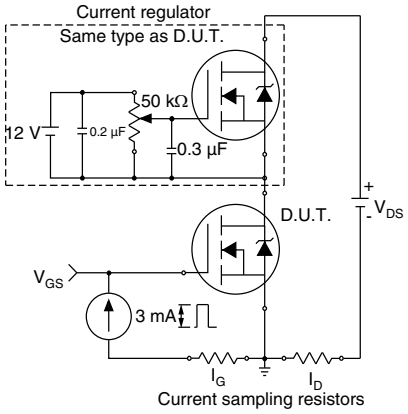


Fig. 17 - Gate Charge Test Circuit

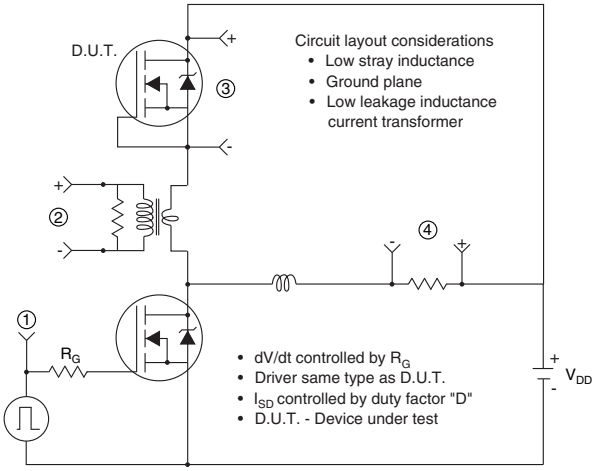
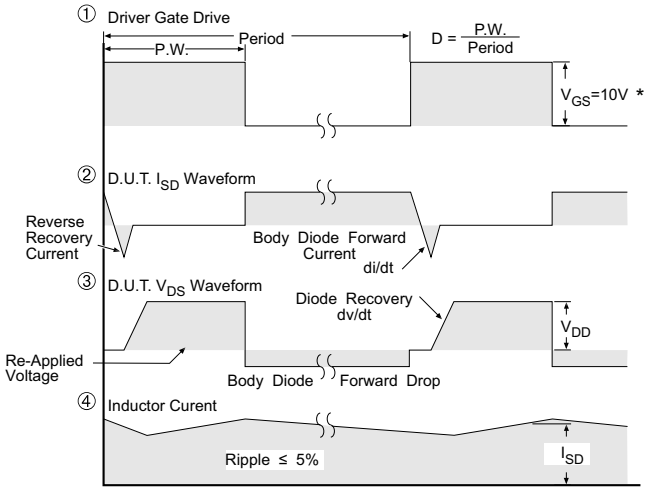


Fig. 18 - Peak Diode Recovery dV/dt Test Circuit



* V_{GS} = 5V for Logic Level Devices

Fig. 19 - For N-Channel Power MOSFETs

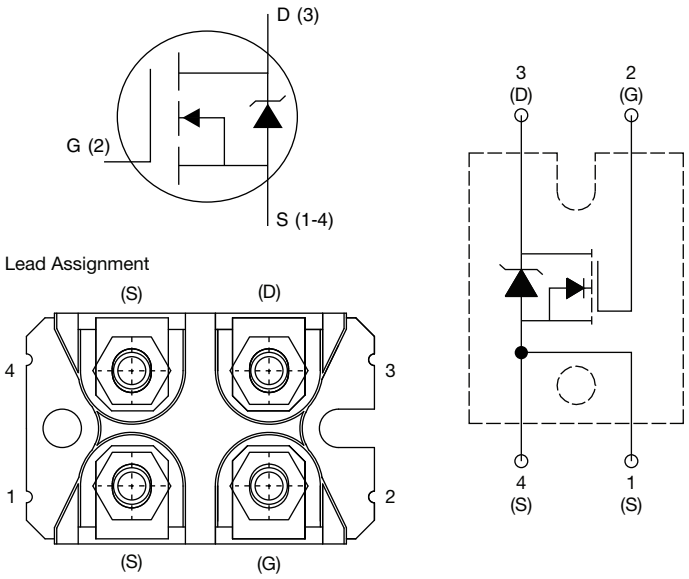
ORDERING INFORMATION TABLE

Device code

VS-	F	B	190	S	A	10
1	2	3	4	5	6	7

- 1 - Vishay Semiconductors product
- 2 - Power MOSFET
- 3 - Generation 5 MOSFET
- 4 - Current rating (190 = 190 A)
- 5 - Single switch
- 6 - Package indicator (SOT-227)
- 7 - Voltage rating (10 = 100 V)

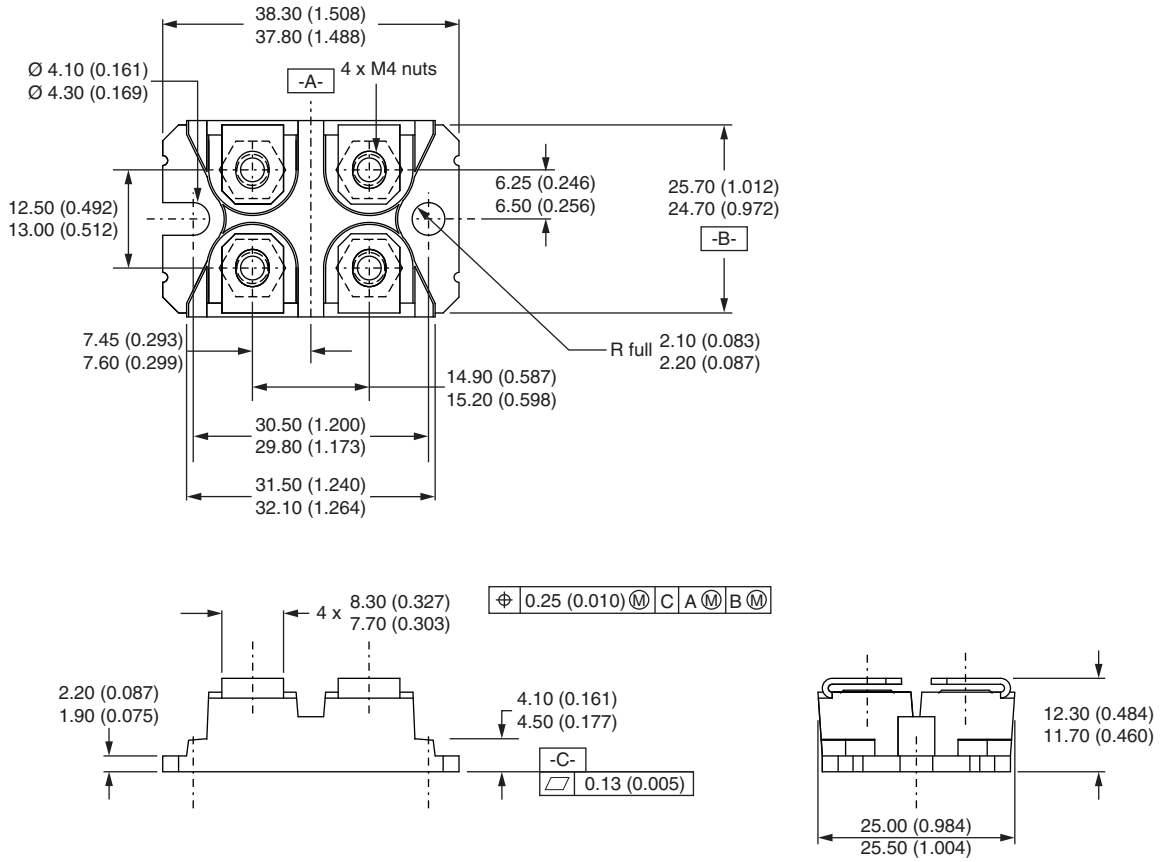
CIRCUIT CONFIGURATION

CIRCUIT	CIRCUIT CONFIGURATION CODE	CIRCUIT DRAWING
Single switch	S	

LINKS TO RELATED DOCUMENTS	
Dimensions	www.vishay.com/doc?95423
Packaging information	www.vishay.com/doc?95425

SOT-227 Generation II

DIMENSIONS in millimeters (inches)



Note

- Controlling dimension: millimeter

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